



Product Features:

Low Cost SMD Package Low ESR Compatible with Leadfree Processing

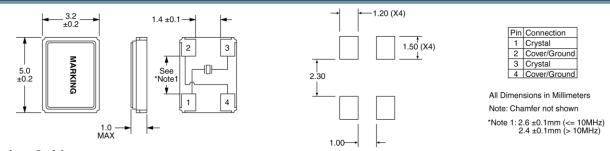
Applications: Fibre Channel

Fibre Channel Server & Storage Sonet / SDH 802.11 / WiFi T1/E1, T3/E3

Electrical Specifications

Frequency	8MHz to 150MHz
Equivalent Series Resistance	
8MHz – 9.999999MHz	100 Ohms Maximum
10MHz – 11.999999MHz	80 Ohms Maximum
12MHz – 15.999999MHz	60 Ohms Maximum
16MHz – 19.999999MHz	50 Ohms Maximum
20MHz – 23.999999MHz	40 Ohms Maximum
24MHz – 50MHz	30 Ohms Maximum
30MHz – 150MHz (Third Overtone)	80 Ohms Maximum
Shunt Capacitance (C0)	5pF Maximum
Frequency Tolerance (at 25°C)	±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm
Frequency Stability (over Temperature)	±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm
Mode of Operation	
8MHz – 50MHz	Fundamental
30MHz – 150MHz	Third Overtone
Crystal Cut	AT Cut
Load Capacitance	8pF to 32pF or Specify
Drive Level	100µW Maximum
Aging	±5ppm/Year Maximum
Operating Temperature Range	See Part Number Guide
Storage Temperature Range	-40°C to +85°C

Mechanical and Solder Pad Dimensions



Part Number Guide

	Sample Part Number: ILCX07 – FB1F18 – 20.000 MHz							
Package	Frequency Tolerance	Frequency Stability	Operating Temperature Range	Mode of Operations	Load Capacitance	Frequency		
ILCX07 -	$B = \pm 50 ppm$	$B = \pm 50 ppm$	0 = 0°C to +50°C	F = Fundamental	8pF to 32pF or Specify	00,000,0411-		
	$F = \pm 30$ ppm	$F = \pm 30 ppm$	1 = 0°C to +70°C	3 = Third Overtone				
	$G = \pm 25 ppm$	$G = \pm 25 ppm$	2 = -10°C to +60°C					
	$H = \pm 20 ppm$	$H = \pm 20 ppm$	3 = -20°C to +70°C					
	$I = \pm 15 ppm$	l = ±15ppm*, **	5 = -40°C to +85°C			20.000 MHz		
	$J = \pm 10 ppm^*$	J = ±10ppm*, **	9 = -10°C to +50°C					
			D = -10°C to +105°C*					
			E = -40°C to +105°C*					

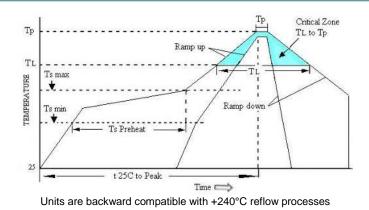
* Not available at all frequencies. ** Not available for all temperature ranges.



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Pb Free Solder Reflow Profile:

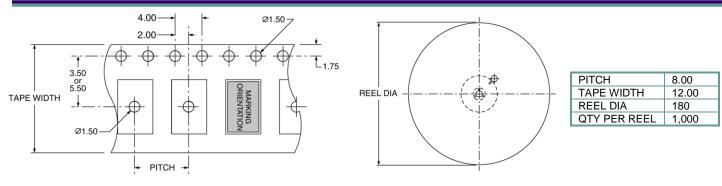


Ts max to T _L (Ramp-up Rate)	3°C / second max	
Preheat		
Temperature min (Ts min)	150°C	
Temperature typ (Ts typ)	175ºC	
Temperature max (Ts max)	200°C	
Time (Ts)	60 to180 seconds	
Ramp-up Tate (T _L to Tp	3°C / second max	
Time Maintained Above		
Temperature (T _L)	217ºC	
Time (T _{L)}	60 to 150 seconds	
Peak Temperature (Tp)	260°C max for 10	
	seconds	
Time within 5°C to Peak	20 to 40 seconds	
Temperature (Tp)		
Ramp-down Rate	6°C / second max	
Tune 25°C to Peak Temperature	8 minutes max	

Package Information:

MSL = 1 (package does not contain plastic, storage life is unlimited under normal room conditions) Termination = e4 (Au over Ni over W base metallization)

Tape and Reel Information:



All Dimensions in Millimeters

Environmental Specifications:

Mechanical Shock	MIL-STD-202, Method 213
Vibration	MIL-STD-202, Method 204
Resistance to Soldering Heat	MIL-STD-202, Method 210
Solderability	J-STD-002
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2

Marking:

Line 1: ILSI, Date Code (YWW) Line 2: Frequency

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